

# Model 1499 14 x 9 mm SMD OCXO

### **Features**

- Small 14x9 SMD package size
- Output frequency range up to 50MHz
- 3.3V operation
- Low Jitter/Phase Noise
- Tape and Reel Packaging

# Part Dimensions: 14.6 × 9.6 × 6.7 mm

### Description

The CTS Model 1499 is a low cost, small size, high performance OCXO. The high quality Quartz Crystal used in this OCXO offers high stability and low jitter/phase noise, making it the ideal choice for any telecommunications system. Other applications include: Telecom Switching, Wireless Communication and Timing over Packet.

Table 1. Ordering Information

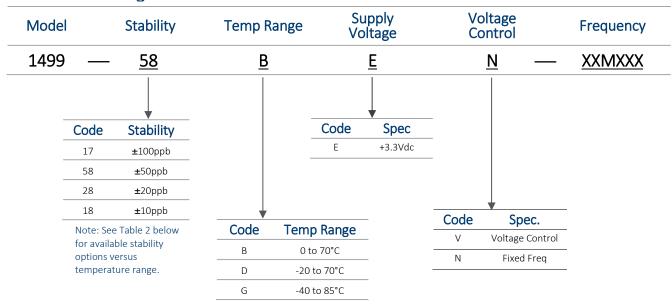


Table 2. Stability Options

		Stability (ppb)			
	Temperature	17	58	28	18
Code	Range	±100	±50	±20	±10
В	0 to 70°C	*	*	*	*
D	-20 to 70°C	*	*	*	*
G	-40 to 85°C	*	*	*	

Part Number Example: 1499-58BEN-20M000

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# **Electrical Specifications**

Parameter	Conditions & Remarks	Min	Typical	Max	Unit
Operating Condition	S				
Operating Temperature Range	See Table 1 options.	-40	-	+85	°C
Supply Voltage	Vcc	+3.135	+3.3	+3.465	Vdc
	During warm up	-	-	750	mA
Current Consumption	Steady state @ 25°C	-	-	200	mA
oad.	Output to Ground	-	15	-	pf
Frequency Stability					
Frequency	Fnom	10	-	50	MHz
Calibration	$\Delta$ F/F <sub>NOM</sub> ; T <sub>A</sub> = 25°C; at time of shipment at V <sub>C</sub> = 1.65V	-	-	±500	ppb
<b>Temperature Stability</b> See Table 1 options)	(Fmax+Fmin) /2	±10	-	±100	ppb
Voltage Stability	$V_{CC}$ ±2%, ref to $V_{CC}$ = +3.3V	-	±5	-	ppb
Load Stability	±5%, ref. to CL = 15 pf	-	±5	-	ppb
	Per day	-	±1	±3	ppb
<b>Aging</b> (after 30 days operation)	Per year	-	-	±0.8	ppm
(4)	10 years	-	-	±2	ppm
Total Free-Run Accuracy	Under all operating conditions for 10 years	-	-	±2.5	ppm
Short Term Stability ADEV	In still air; 1.0 sec after 1 hr operation	-	0.02	0.07	ppb
Warmup-Up Time	T <sub>A</sub> =25°C; to within 100ppb of freq. @ 30 min	-	-	3	minutes
Electronic Frequenc	y Control – EFC (option)				
Voltage Range	V <sub>c</sub> , Control voltage range	0	1.65	3.3	V
Pulling Range	Sufficient for 10 years life	±2.6	-	±4	ppm
Slope	Positive, monotonic				
Linearity		-	-	5	%



## **Electrical Specifications (continued)**

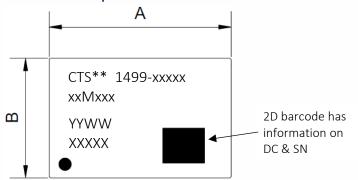
Parameter	Conditions & Remarks	Min	Typical	Max	Unit	
Output Parameters	– Square Wave, LVCMOS					
<b>Waveform</b> LVC		LVCMOS				
Amplitude	V <sub>OL</sub>	-	-	0.3	\ / al a	
Amplitude	Vон	2.7	_	-	Vdc	
Rise / Fall Times	10% to 90% @ 15pf load	-	-	4	ns	
Duty Cycle	@ 50% of output signal	45	50	55	%	
	Offset = 1 Hz	-	-80	-75		
	10Hz	-	-110	-105		
Phase Noise	100Hz	-	-135	-130		
	1KHz	-	-150	-145	dBc/Hz	
(10MHz)	10KHz	-	-158	-155		
	100KHz	-	-159	-156		
	1MHz	-	-160	-157		

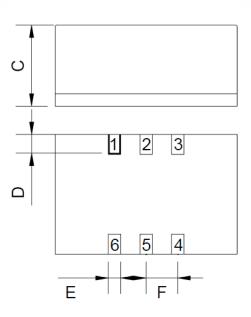
### Mechanical and Environmental

Parameter	Condition	
Soldering	Maximum reflow temperature, 245°C for 10seconds, 240°C for 20seconds, per IPC/JEDEC J-STD-020D Note: Not intended for inverted reflow	
MSL	Level 2	
RoHS	Fully compliant to RoHS Directive EU 2015/863	
Shock	1500G, 0.5msec, 6-axis 3 times per MIL-STD-883 Method 2002	
Sinusoidal Vibration	20G, 10~2000Hz, 1.52mm, sweep 20minutes, 4 hours per axis per MIL-STD-883 Method 2007	
Packaging	Tape and Reel	
Storage Temperature Range	-55°C to +105°C	



## **Mechanical Specifications**



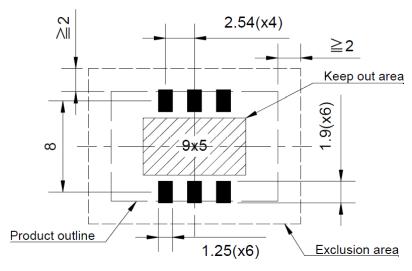


Marking			
**	=	Mfg Site Code	
YYWW	=	Date Code	
XXXXX	=	Serial Number	

Pin Assignments			
Pin/Pad Function			
1	V <sub>C</sub> − Voltage control		
2	DNC		
3	Ground		
4	RF Output		
5 DNC			
<b>6</b> V <sub>CC</sub> – Supply voltag			

Dimension (mm)				
Symbol	Min	Max		
Α	-	14.6		
В	-	9.6		
С	-	6.7		
D	1.6 (x6)			
Е	1.0 (x6)			
F	2.54			

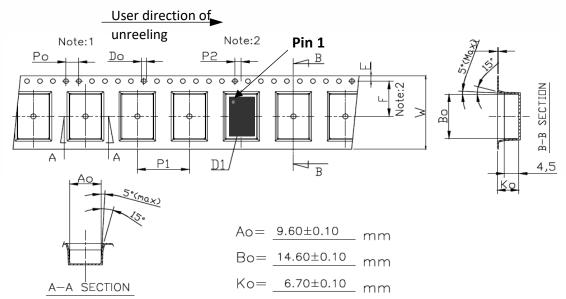
# **Recommended Solder Pad Geometry**



**Exclusion area** - To reduce thermal losses, a minimum 2 mm perimeter beyond the oscillator dimensions, free of surface or sub-surface ground or power planes, is recommended.

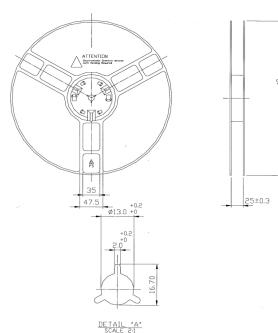


### Packing: Tape and Reel



1	ln:	it:	m	m

Symbol	Spec.
Ро	4.0±0.10
P1	16.0±0.10
P2	2.0±0.10
Do	1.50 +0.1
D1	1.50(Min)
Е	1.75±0.10
F	11.50±0.10
10Po	40.0±0.20
W	24.0 +0.3
Т	0.40±0.05



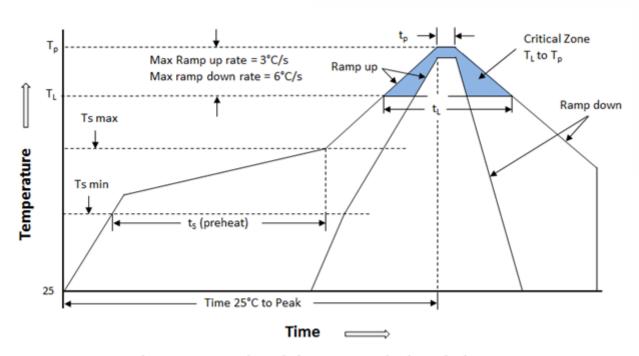
### Standard reel quantity is 450pcs

### Notes:

- 1. 10 Sprocket hole pitch cumulative tolerance is ±0.1mm.
- 2. Pocket position relative to sprocket hole measured as true position of pocket not pocket hole.
- 3. Ao & Bo measured at 0.3mm above the bottom of the pocket.
- 4. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
- 5. Carrier camber shall not be greater than 1mm per 100mm through length of 250mm.



## Reflow profile per IPC/JEDEC J-STD-020D



Note: The temperatures shown below represent the device body temperature

T <sub>S</sub> max to T <sub>L</sub> (Ramp-Up Rate)	3°C/second max	
Preheat:		
Temperature Min (T <sub>S</sub> Min)	150°C	
Temperature Typical (TsTyp)	175°C	
Temperature Typical (Ts Max)	200°C	
Time (ts)	60-120 seconds	
Ramp-Up Rate (TLto TP)	3°C/second max	
Time Maintained Above:		
Temperature (T <sub>L</sub> )	217°C	
Time (T <sub>L</sub> )	60-150seconds	
Peak Temperature (T <sub>P</sub> )	245°C max for 10 seconds	
Time within 5°C of actual peak (T <sub>P</sub> )	30 seconds	
Ramp-Down Rate	6°C/second max	
Time 25°C to Peak Temperature(T)	8 minutes max	

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